LISTING OF CLAIMS

1(cancelled).

2(allowed). A heat curable composition comprising at least one epoxy functional resin compound, and about 5 to about 20 weight percent of at least one metal acrylate curing agent which is sufficient to cure said at least one epoxy functional resin compound wherein the composition is substantially free of peroxides, polyamide, acid functional curing agents, dicyandiamide, polysulfides, anhydrides, melamine, urea and imidizole compounds.

3(cancelled).

4(cancelled).

5(cancelled).

6(cancelled).

7(allowed). The composition of Claim 2 wherein the composition comprises an automotive sealant.

8(allowed). The composition of Claim 2 wherein the compound comprises at least one member selected from the group consisting of bis A epoxy, bis F, cycloaliphatic epoxy, novolac compounds and epoxy esters.

9(allowed). The composition of Claim 2 wherein the composition further comprises at least one filler selected from the group consisting of at least one silicate, silica, trihydrates, carbonates, bitumins, and clays.

10(allowed). The composition of Claim 2 wherein the composition further comprises at least one additive selected from the group consisting of metal powders, magnetic materials, ceramic powders, plastic powders and resins.

11(allowed). The composition of Claim 2 wherein the composition further comprises at least one reinforcement.

12(allowed). The composition of Claim 11 wherein the reinforcement comprises at least one of fibers or film.

13(allowed). The composition of Claim 2 further comprising at least one complexing agent selected from the group consisting of zirconates and titanates.

14(allowed) The composition of Claim 2 wherein the metal acrylate curing agent comprises at least one member selected from the group consisting of zinc diacrylate, zinc dimethacrylate, magnesium diacrylate, mixtures thereof and aqueous solutions thereof.

15(allowed). The composition of Claim 2 wherein the metal acrylate curing agent comprises at least one of zinc diacrylate and dimethacrylate.

16(allowed). The composition of Claim 14 wherein the metal acrylate curing agent comprises zinc diacrylate.

17(allowed) The composition of Claim 2 further comprising at least one member selected from the group consisting of silanes and polysiloxanes.

18(allowed) The composition of Claim 2 further comprises boron nitride.

19(cancelled).

20(cancelled).

21(currently amended). A thermoset composition comprising at least one epoxy, and an amount of at least one curing agent that is sufficient to cure said at least one epoxy and comprising at least one member selected from the group consisting of zinc diaerylate and dimethacrylate wherein the composition is The composition of Claim 2 wherein the composition is also substantially free of acid functional curing agents, peroxides, amines, polyamide and dicyandiamide.

22(cancelled).

23(cancelled).

24(currently amended). The composition of Claim [[23]] 8 wherein the epoxy resin comprises cycloaliphatic epoxy.

25(currently amended). The composition of Claim [[23]] 8 wherein the epoxy resin comprises novalac epoxy.

26(currently amended). The composition of Claim [[23]] 8 wherein the epoxy resin comprises bis A epoxy.

27(currently amended). The composition of Claim [[23]] 8 wherein the epoxy resin comprises bis F epoxy.

28(cancelled).

29(cancelled).

30(currently amended). A combination comprising at least one heat curable epoxy resin, at least one curing agent in an amount sufficient to cure said at least one heat curable epoxy resin and selected from the group consisting of zinc diacrylate and dimethacrylate, and at least one member selected from the group consisting of titanates, zirconates, The composition of Claim 17 wherein said member comprises silanes and polysiloxanes; wherein the combination is substantially free of acid functional curing agents, peroxides, amines and dievandiamide.

31(currently amended). The combination of Claim 30 wherein said member The composition of Claim 13 wherein said complexing agent comprises at least one titanate.

32(cancelled).

33(currently amended). A heat curable composition comprising at least one epoxy resin, The composition of Claim 2 further comprising at least one rubber or rubber modified compound, and about 5 to about 20 weight percent of at least one curing agent in an amount sufficient to cure said at least one epoxy resin and comprising zinc diacrylate wherein the composition is substantially free of acid functional curing agents, peroxides, amines, polyamide and dicyandiamide.

34(cancelled).

35(cancelled).